

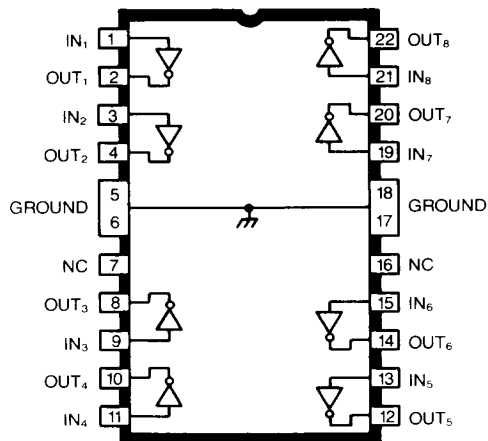
## UDN-6540B 8-CHANNEL DMOS HIGH-VOLTAGE DRIVER

### FEATURES

- 200 V Outputs
- CMOS, PMOS Compatible
- Internal Gate Limiting Resistors
- Diode Clamped Inputs and Outputs
- Improved Output SOA

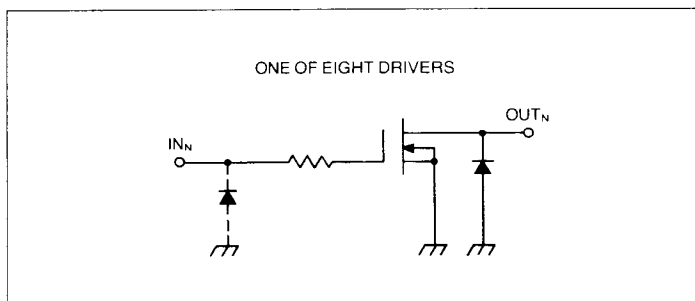
The UDN-6540B is an eight-channel high-voltage DMOS driver capable of sinking 200 mA and maintaining an output OFF voltage of 200 V. This device has many possible applications such as driving piezoelectric elements, gas-discharge or electroluminescent displays, and other high-voltage power loads. This device is input compatible with 7-20 V logic such as PMOS, CMOS, and high-voltage open collector TTL.

Because DMOS outputs have output SOA superior to that of conventional bipolar technologies, the UDN-6540B is ideal for inductive load applications. Unlike NPN transistors, DMOS devices can operate safely to their breakdown voltage limit without risk of secondary breakdown (latch-back) or sacrifice of reliability.



Dwg No. W-103

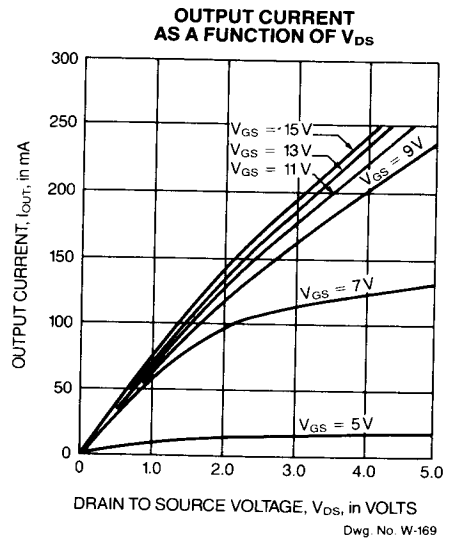
The UDN-6540B is furnished in a 22-pin dual in-line package with 0.400" row centers and sink contact tabs. A copper-alloy lead frame provides maximum power dissipation using standard cooling methods. This lead configuration facilitates attachment of external heat-sinks for increased power dissipation with standard IC sockets and printed wiring boards.



Dwg No. W-104

**ABSOLUTE MAXIMUM RATINGS**  
at +25°C Free-Air Temperature

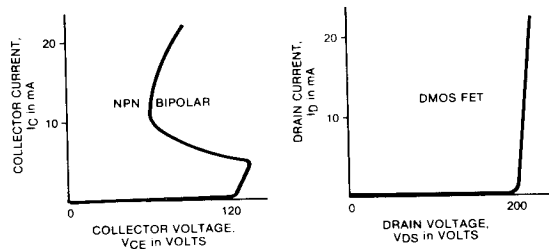
Output Voltage,  $V_{DS}$  ..... 200V  
Input Voltage,  $V_{IN}$  ..... 20V  
Output Current,  $I_{OUT}$  ..... 250mA  
Power Dissipation,  $P_D$  ..... See Graph  
Storage Temperature Range ..... -55°C to +150°C  
Operating Temperature Range,  $T_A$  ..... -20°C to +85°C



**ELECTRICAL CHARACTERISTICS at  $T_A = +25^\circ\text{C}$**

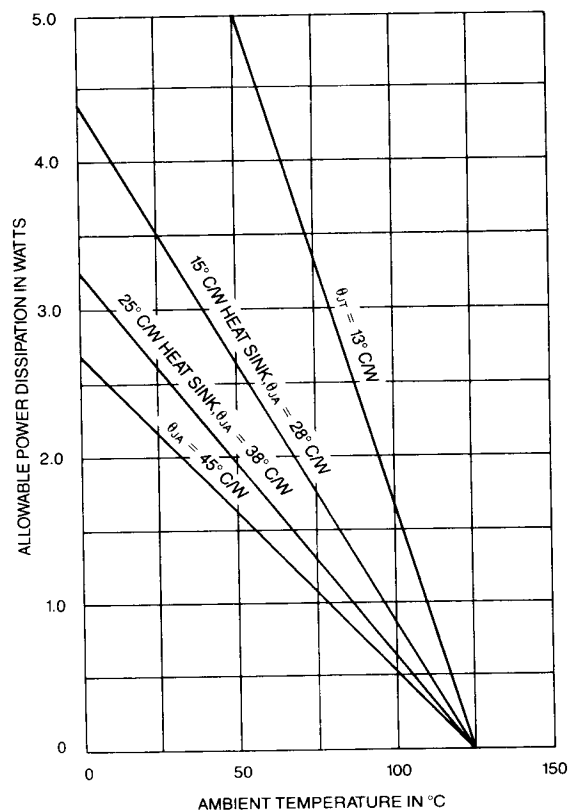
Characteristics	Symbol	Test Conditions	Limits		
			Min.	Max.	Units
Output Leakage Current	$I_{DSS}$	$V_{DS} = 200\text{V}$ , Gate Shorted to Source	—	10	$\mu\text{A}$
Drain to Source ON Voltage	$V_{DS(ON)}$	$V_{GS} = 10\text{V}$ , $I_{OUT} = 100\text{mA}$	—	2.5	V
		$V_{GS} = 10\text{V}$ , $I_{OUT} = 200\text{mA}$	—	5.0	V
		$V_{GS} = 15\text{V}$ , $I_{OUT} = 200\text{mA}$	—	4.0	V
Input Threshold Voltage	$V_{TH}$	$I_{OUT} = 10\text{mA}$ , $V_{DS} = 0.5\text{V}$	—	7.0	V
		$I_{OUT} = 50\text{mA}$ , $V_{DS} = 1.0\text{V}$	—	8.5	V
Turn-On Delay	$t_{ON}$	$0.5E_{IN}$ to $0.5E_{OUT}$ , $R_L = 1\text{ k}\Omega$ , $V_{OUT} = 200\text{V}$	—	0.5	$\mu\text{s}$
Turn-Off Delay	$t_{OFF}$	$0.5E_{IN}$ to $0.5E_{OUT}$ , $R_L = 1\text{ k}\Omega$ , $V_{OUT} = 200\text{V}$	—	0.5	$\mu\text{s}$

## BREAKDOWN CHARACTERISTICS



Dwg. No. SD-113

## ALLOWABLE AVERAGE PACKAGE POWER DISSIPATION AS A FUNCTION OF TEMPERATURE



Dwg. No. W-105